

# 111-43-314-41-001000

#### 111-43-314-41-001000 Information



E-mail: salesdept@heisener.com

For Reference Only

## **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



# 111-43-314-41-001000 Specifications

Manufacturer Part Number111-43-314-41-001000ManufacturerMill-Max Manufacturing Corp.CategoryConnectors, InterconnectsSockets for ICs, TransistorsPackage-Series111TypeDIP, 0.3" (7.62mm) Row SpacingNumber of Positions or Pins (Grid)14 (2 x 7)Pitch - MatingGoldContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Material - MatingBeryllium CopperMounting TypeThrough HoleFeaturesOpen FramePitch - Post0.100" (2.54mm)Fitch - Post0.100" (2.54mm)Contact Finish PhostSolderFeaturesOpen FrameFeaturesOlderPitch - Post0.100" (2.54mm)Contact Finish - Post0.100" (2.54mm)Contact Finish - Post0.100" (2.54mm)Contact Finish - Post0.100" (2.54mm)Contact Finish Thickness - Post200µin (5.08µm)			
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Mounting TypeThrough HoleFeaturesOpen FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin	Contact Finish Thickness - Mating	30µin (0.76µm)	
FeaturesOpen FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin	Contact Material - Mating	Beryllium Copper	
TerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin	Mounting Type	Through Hole	
Pitch - Post0.100" (2.54mm)Contact Finish - PostTin	Features	Open Frame	
Contact Finish - Post Tin	Termination	Solder	
	Pitch - Post	0.100" (2.54mm)	
Contact Finish Thickness - Post 200uin (5.08um)	Contact Finish - Post	Tin	
	Contact Finish Thickness - Post	200µin (5.08µm)	
Contact Material - Post Brass Alloy	Contact Material - Post	Brass Alloy	
Housing Material Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Operating Temperature	-55°C ~ 125°C	
Report errors			Report errors?

#### 111-43-314-41-001000 Guarantees



**Quality Guarantees** 

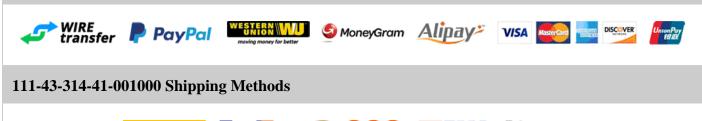
We provide 90 days warranty. \* If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

# SERVICE BUARANTEE

#### Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

## 111-43-314-41-001000 Payment Methods





If you have any question about 111-43-314-41-001000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com